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A. Patent A	pplication No.(s)	B. Paten	B. Patent No.(s)		
· ·	357,477		•		
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	d address of party to whom correspould be mailed:	ondence concerning 6. Total nu	imber of applications and patents involved:		
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10/13/1999 BNBUYEN 00000184 KENJI ORITA

## INSTRUCTIONS

## ASSIGNMENT OF U.S. RIGHTS TO CORPORATION

WHEREAS,

Inventor(s) Name, Address, Citizenship

- 1. Kenji ORITA residing at 1-44-9-C104, Tsunoecho, Takatsuki-shi, Osaka 569-0822, Japan and a citizen of Japan;
- 2. Masahiro ISIDA residing at 24-6, Ikaganishimachi, Hirakata-shi, Osaka 573-0066, Japan and a citizen of Japan;
- 3. Shinji NAKAMURA residing at 1-3-507-403, Nasahara, Takatsuki-shi. Osaka 569-1041, Japan and a citizen of Japan;
- 4. Masaaki YURI residing at 6-26-1201, Funakicho, Ibaraki-shi, Osaka 567-0828, Japan and a citizen of Japan;
- 5. Nobuyuki UEMURA residing at 14–10, Nishikanmuri 3-chome. Takatsuki-shi, Osaka 569-0055, Japan and a citizen of Japan;

Date Patent Declaration Signed and Title Serial No. and filing date (if known)

(herein called "THE UNDERSIGNED") have made an invention and have executed an application for Letters Patent of the United States on \_\_ for this invention, which application is entitled SUBSTRATE CONTAINING COMPOUND SEMICONDUCTOR, METHOD FOR MANUFACTURING THE SAME AND SEMICONDUCTOR DEVICE USING THE SAME and which has been given Serial Number 09/357,477 and the filing date of July 20. 1999:

Name of Corporation

AND WHEREAS Matsushita Electronics Corporation (herein called "ASSIGNEE"), a corporation organized under the laws of Japan, and having an office and place of business at 1-1, Saiwai-cho, Takatsuki-shi, Osaka 569-1193, Japan

State or Country of

wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of the sum of One Dollar and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign and transfer to the ASSIGNEE, its successors and assigns, the entire right, title and interest for the United States in and to the invention disclosed in the aforesaid application. and in and to the said application, all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents to issue any and all United States Letters Patent for the aforesaid invention to the ASSIGNEE of the entire right, title and interest in and to the same, for the use of the ASSIGNEE, its successors and assigns.

THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to THE UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, its successors or assigns the entire right, title and interest in and to the said invention, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

THE UNDERSIGNED represent and agree with said ASSIGNEE its successors and assigns, that no assignment grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by THE UNDERSIGNED, and that full right to convey the same as herein

Incorporation and Address

**PATENT** REEL: 010575 FRAME: 0463 expressed is possessed by THE UNDERSIGNED.

IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

Each inventor must sign & date

Note: No legalization or other witness required

Keryu Orita
Signature: Kenji Orita

Sligita Kamar

Signature: Shinji Nakamura

hobuyuki Signature: Nobuyuki Uemura

Date

Date

**PATENT REEL: 010575 FRAME: 0464** 

**RECORDED: 10/12/1999**